

TK100A10N1-VB Datasheet N-Channel 100 V (D-S) 175 °C MOSFET

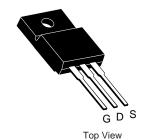
| PRODUCT SUMMARY | |
|---|--------|
| V _{DS} (V) | 100 |
| $R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$ | 0.0038 |
| I _D (A) | 120 |
| Configuration | Single |

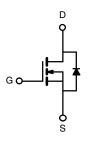
FEATURES

- TrenchFET® Power MOSFET
- Package with Low Thermal Resistance
- \bullet 100 % R_{g} and UIS Tested









N-Channel MOSFET

| ABSOLUTE MAXIMUM RATING | S (T _C = 25 °C, unles | s otherwise noted | i) | |
|---|---|-----------------------------------|---------------|------|
| PARAMETER | | SYMBOL | LIMIT | UNIT |
| Drain-Source Voltage | | V_{DS} | 100 | |
| Gate-Source Voltage | | V_{GS} | ± 20 | V |
| Continuous Drain Current | T _C = 25 °C ^a | - I _D | 120 | |
| Continuous Drain Current | T _C = 125 °C | | 102 | |
| Continuous Source Current (Diode Conducti | on) ^a | I _S | 120 | Α |
| Pulsed Drain Current ^b | | I _{DM} | 480 | |
| Single Pulse Avalanche Current | L = 0.1 mH | I _{AS} | 73 | |
| Single Pulse Avalanche Energy | L = U.1 MIH | E _{AS} | 266 | mJ |
| Mayimum Dawar Dissination | T _C = 25 °C | D | 84 | W |
| Maximum Power Dissipation ^b | T _C = 125 °C | - P _D | 35 | VV |
| Operating Junction and Storage Temperatur | e Range | T _J , T _{stg} | - 55 to + 175 | °C |

| THERMAL RESISTANCE RATINGS | | | | |
|----------------------------|------------------------|-------------------|-------|------|
| PARAMETER | | SYMBOL | LIMIT | UNIT |
| Junction-to-Ambient | PCB Mount ^c | R _{thJA} | 40 | °C/W |
| Junction-to-Case (Drain) | | R _{thJC} | 0.6 | C/VV |

Notes

- a. Package limited.
- b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- c. When mounted on 1" square PCB (FR-4 material).
- d. Parametric verification ongoing.

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| PARAMETER | SYMBOL | TES | T CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
|---------------------------------------|--------------------------|--|--|--|--------|-------|------|----|
| Static | | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0$, $I_D = 250 \mu A$ | | 100 | - | - | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = | = V _{GS} , I _D = 250 μA | 2.5 | 3.0 | 3.5 | V | |
| Gate-Source Leakage | I _{GSS} | V _{DS} = | 0 V, V _{GS} = ± 20 V | - | - | ± 100 | nA | |
| | | $V_{GS} = 0 V$ | V _{DS} = 100 V | - | - | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} = 0 V | V _{DS} = 100 V, T _J = 125 °C | - | - | 50 | μΑ | |
| | | V _{GS} = 0 V | V _{DS} = 100 V, T _J = 175 °C | - | - | 500 | | |
| On-State Drain Current ^a | I _{D(on)} | V _{GS} = 10 V | $V_{DS} \ge 5 V$ | 120 | - | - | Α | |
| | | V _{GS} = 10 V | I _D = 20 A | - | 0.0038 | - | Ω | |
| Drain-Source On-State Resistancea | R _{DS(on)} | V _{GS} = 10 V | I _D = 20 A, T _J = 125 °C | - | 0.0064 | - | | |
| | | V _{GS} = 10 V | I _D = 20 A, T _J = 175 °C | - | 0.0080 | - | | |
| Forward Transconductance ^b | 9 _{fs} | V _{DS} = 15 V, I _D = 20 A | | - | 82 | - | S | |
| Dynamic ^b | | | | | | | | |
| Input Capacitance | C _{iss} | | | - | 5780 | 7230 | | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 V$ | $V_{GS} = 0 V$ $V_{DS} = 25 V, f =$ | $V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | - | 3070 | 3840 | pF |
| Reverse Transfer Capacitance | C _{rss} | | | - | 305 | 385 | | |
| Total Gate Charge ^c | Qg | | | - | 125 | 190 | | |
| Gate-Source Charge ^c | Q_{gs} | V _{GS} = 10 V | $V_{DS} = 50 \text{ V}, I_{D} = 70 \text{ A}$ | - | 28 | - | nC | |
| Gate-Drain Charge ^c | Q_{gd} | | | - | 46 | - | | |
| Gate Resistance | R_g | f = 1 MHz | | 1.6 | 3.3 | 5 | Ω | |
| Turn-On Delay Time ^c | t _{d(on)} | | | - | 16 | 25 | | |
| Rise Time ^c | t _r | $V_{DD} = 50 \text{ V}, \text{ R}_L = 0.7 \Omega$ $I_D \cong 70 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$ | | - | 110 | 165 | - ns | |
| Turn-Off Delay Time ^c | t _{d(off)} | | | - | 40 | 60 | | |
| Fall Time ^c | t _f | | | - | 12 | 20 | | |
| Source-Drain Diode Ratings and Chara | acteristics ^b | | | | | | | |
| Pulsed Current ^a | I _{SM} | | | - | - | 480 | Α | |
| Forward Voltage | V _{SD} | I _F = | = 100 A, V _{GS} = 0 | - | 0.9 | 1.5 | V | |

Notes

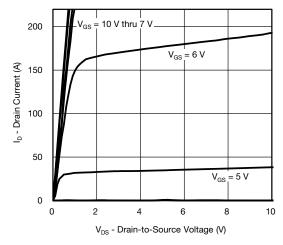
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

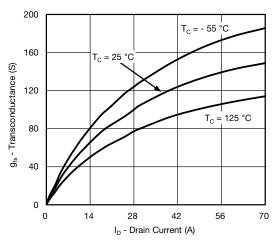
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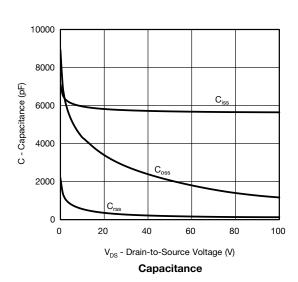
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

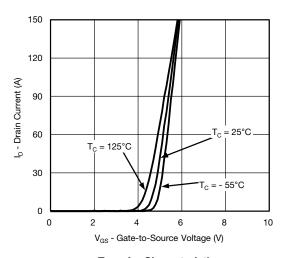


Output Characteristics

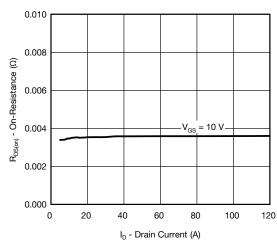


Transconductance

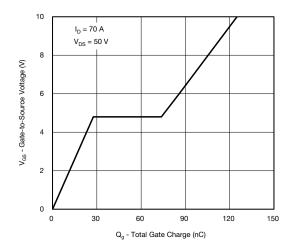




Transfer Characteristics



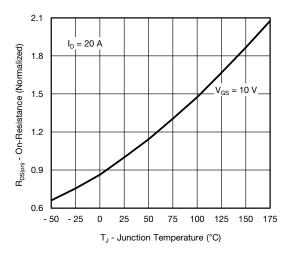
On-Resistance vs. Drain Current



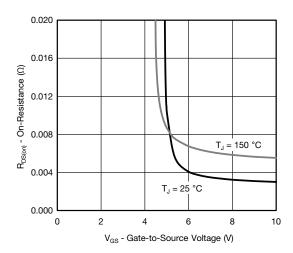
Gate Charge



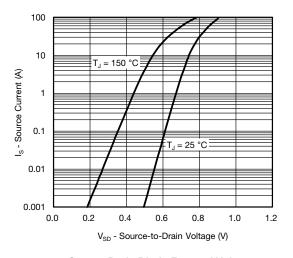
TYPICAL CHARACTERISTICS ($T_A = 25 \, ^{\circ}\text{C}$, unless otherwise noted)



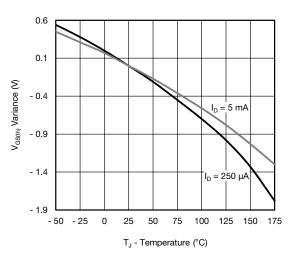
On-Resistance vs. Junction Temperature



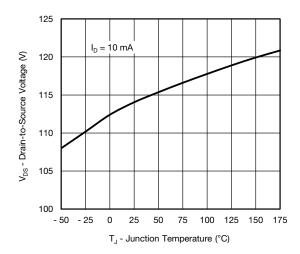
On-Resistance vs. Gate-to-Source Voltage



Source Drain Diode Forward Voltage



Threshold Voltage

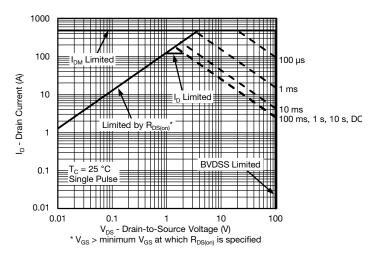


Drain Source Breakdown vs. Junction Temperature

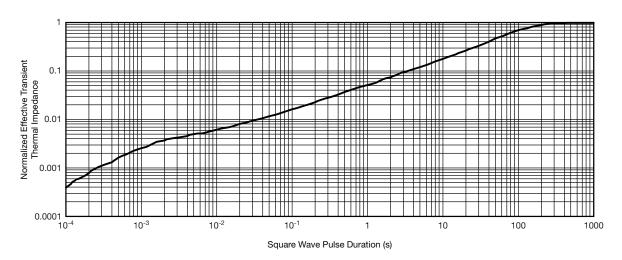
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THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



Safe Operating Area

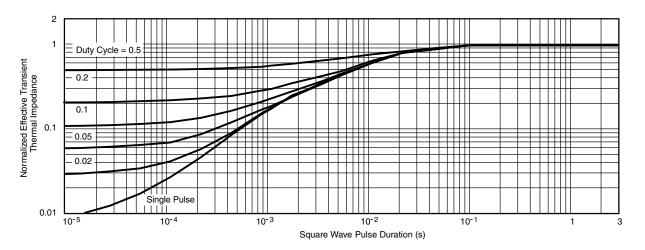


Normalized Thermal Transient Impedance, Junction-to-Ambient

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)

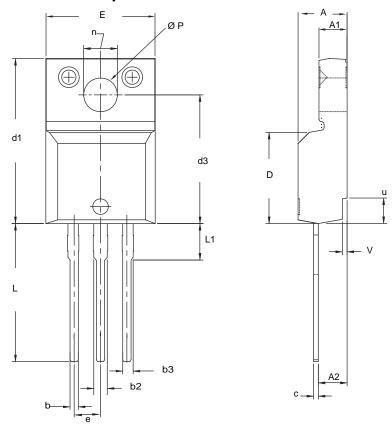
can widely vary depending on actual application parameters and operating conditions.

- Normalized Transient Thermal Impedance Junction to Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities

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TO-220 FULLPAK (HIGH VOLTAGE)



| | MILLIN | METERS | INCHES | | |
|------|--------|--------|-----------|-------|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | |
| Α | 4.570 | 4.830 | 0.180 | 0.190 | |
| A1 | 2.570 | 2.830 | 0.101 | 0.111 | |
| A2 | 2.510 | 2.850 | 0.099 | 0.112 | |
| b | 0.622 | 0.890 | 0.024 | 0.035 | |
| b2 | 1.229 | 1.400 | 0.048 | 0.055 | |
| b3 | 1.229 | 1.400 | 0.048 | 0.055 | |
| С | 0.440 | 0.629 | 0.017 | 0.025 | |
| D | 8.650 | 9.800 | 0.341 | 0.386 | |
| d1 | 15.88 | 16.120 | 0.622 | 0.635 | |
| d3 | 12.300 | 12.920 | 0.484 | 0.509 | |
| E | 10.360 | 10.630 | 0.408 | 0.419 | |
| е | 2.54 | BSC | 0.100 BSC | | |
| L | 13.200 | 13.730 | 0.520 | 0.541 | |
| L1 | 3.100 | 3.500 | 0.122 | 0.138 | |
| n | 6.050 | 6.150 | 0.238 | 0.242 | |
| ØΡ | 3.050 | 3.450 | 0.120 | 0.136 | |
| u | 2.400 | 2.500 | 0.094 | 0.098 | |
| V | 0.400 | 0.500 | 0.016 | 0.020 | |

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
 All dimensions include burrs and plating thickness.
 No chipping or package damage.

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